

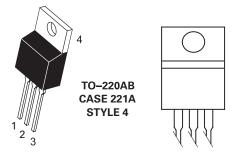
Surface Mount - 100V - 600V > MCR72-3, MCR72-6, MCR72-8

MCR72-3, MCR72-6, MCR72-8





Pin Out



Description

Designed for industrial and consumer applications such as temperature, light and speed control; process and remote controls; warning systems; capacitive discharge circuits and MPU interface.

Features

- Center Gate Geometry for Uniform Current Density
- All Diffused and Glass-Passivated Junctions for Parameter Uniformity and Stability
- Small, Rugged Thermowatt Construction for Low Thermal Resistance, High Heat Dissipation and Durability
- Low Trigger Currents, 200 A Maximum for Direct Driving from Integrated Circuits
- These are Pb-Free Devices

Functional Diagram



Additional Information









Surface Mount - 100V - 600V > MCR72-3, MCR72-6, MCR72-8

Maximum Ratings $(T_J = 25^{\circ}C \text{ unless otherwise noted})$

Rating	Symbol	Value	Unit
Peak Repetitive Off-State Voltage (Note 1) (- 40 to 110°C, Sine Wave, 50 to 60 Hz, Gate Open) MCR72-3 MCR72-6 MCR72-8	V _{drm} , V _{rrm}	100 400 600	V
On-State RMS Current (180° Conduction Angles; T _C = 83°C)	I _{TM (RMS)}	8.0	А
Peak Non-Repetitive Surge Current (1/2 Cycle, Sine Wave 60 Hz, $T_J = 110^{\circ}$ C	I _{TSM}	100	А
Average On-State Current (180° Conduction Angles; $T_c = 83$ °C)	I _{T(AV)}	8.0	А
Circuit Fusing Consideration (t = 8.3 ms)	l²t	40	A²s
Forward Peak Gate Voltage (Pulse Width \leq 10 µsec, T_c = 83°C)	V_{GM}	±5.0	V
Forward Peak Gate Current (Pulse Width ≤ 10 µsec, T _c = 83°C)	I _{GM}	2.0	А
Forward Peak Gate Power (Pulse Width ≤ 10 µsec, T _c = 83°C)	I _{GM}	20	W
Average Gate Power (t = 8.3 ms , $T_{c} = 83^{\circ}\text{C}$)	P _{G(AV)}	0.75	W
Operating Junction Temperature Range	Т	-40 to +110	°C
Storage Temperature Range	T _{stg}	-40 to +150	°C
Mounting Torque	_	8.0	in. lb.

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Thermal Characteristics

Rating	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	R _{sJC}	2.2	°C/W
Thermal Resistance, Junction-to-Ambient	R _{8JA}	60	
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	T _L	260	°C

V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

Thyristors

Electrical Characteristics - **OFF** (T₁ = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Тур	Max	Unit
Peak Repetitive Forward or Reverse Blocking Current	T _J = 25°C	l _{DRM} ,	-	-	10	
$(V_{AK} = Rated V_{DRM} \text{ or } V_{RRM'} R_{GK} = 1 \text{ k}\Omega)$	T _J = 110°C	I _{RRM}	-	-	500	μΑ
High Logic Level Supply Current from V _{CC}		I _{CCH}	4	4	μА	

Electrical Characteristics - **ON** (T_J = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Peak Forward On–State Voltage ($I_{TM} = 16 \text{ A Peak}$, Pulse Width $\leq 1 \text{ ms}$, Duty Cycle $\leq 2\%$)	V _{TM}	_	-	2.0	V
Gate Trigger Current (Continuous dc) (Note 3) ($V_D = 12 \text{ V}; R_L = 100 \Omega$)	I _{GT}	-	30	200	μΑ
Gate Trigger Voltage (Continuous dc) (Note 3) ($V_D = 12 \text{ V}; R_L = 100 \Omega$)	V _{GT}	_	0.5	1.5	V
Gate Trigger Non-Trigger Voltage ($V_D = 12 \text{ Vdc}$, $R_L = 100 \Omega$, $T_J = 110^{\circ}\text{C}$)		0.1	-	-	V
Holding Current ($V_D = 12 \text{ V}$, Initiating Current = 200 mA, RGK = $1 \text{k}\Omega$)		_	_	6.0	mA
Gate Controlled Turn-On Time (Note 5) $(V_D = Rated V_{DRM'} I_{TM} = 16 A, I_G = 2 mA)$	t _{gt}	_	1.0	_	μs

Dynamic Characteristics

Characteristic	Symbol	Min	Тур	Max	Unit
Critical Rate of Rise of Off–State Voltage (V_D = Rated V_{DRM} , R_{GK} = 1 k Ω , Exponential Waveform, Gate Open, T_J = 110°C)	dv/dt	-	10	-	V/µs

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

^{2.} Ratings apply for negative gate voltage or $R_{GK} = 1 \Omega$. Devices shall not have a positive gate voltage concurrently with a negative voltage on the anode. Devices should not be tested with a constant current source for forward and reverse blocking capability such that the voltage applied exceeds the rated blocking voltage.

^{3.} RGK current not included in measurement.



Voltage Current Characteristic of SCR

Symbol	Parameter
V_{DRM}	Peak Repetitive Forward Off State Voltage
I _{DRM}	Peak Forward Blocking Current
V _{RRM}	Peak Repetitive Reverse Off State Voltage
I _{RRM}	Peak Reverse Blocking Current
V _{TM}	Maximum On State Voltage
I _H	Holding Current

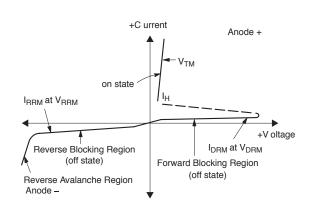


Figure 1. Average Current Derating

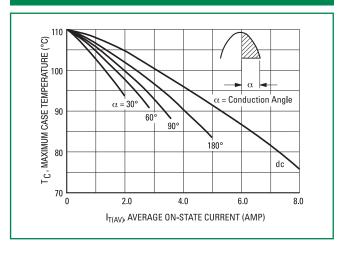


Figure 2. On-State Power Dissipation

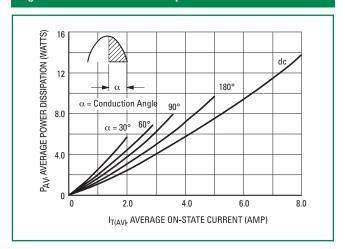


Figure 3. Normalized Gate Current

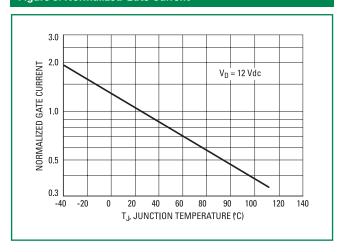
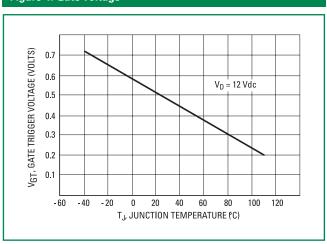


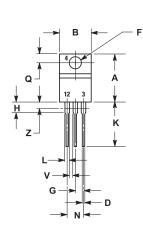
Figure 4. Gate Voltage

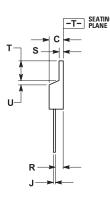


Dimensions

TO-220CASE 221A-07
ISSUE O

CASE 221A-09
ISSUE AH





5 .	Incl	nes	Millimeters		
Dim	Min	Max	Min	Max	
А	0.570	0.620	14.48	15.75	
В	0.380	0.405	9.66	10.28	
С	0.160	0.190	4.07	4.82	
D	0.025	0.035	0.64	0.88	
F	0.142	0.147	3.61	3.73	
G	0.095	0.105	2.42	2.66	
Н	0.110	0.155	2.80	3.93	
J	0.014	0.022	0.36	0.55	
K	0.500	0.562	12.70	14.27	
L	0.045	0.060	1.15	1.52	
N	0.190	0.210	4.83	5.33	
Q	0.100	0.120	2.54	3.04	
R	0.080	0.110	2.04	2.79	
S	0.045	0.055	1.15	1.39	
Т	0.235	0.255	5.97	6.47	
U	0.000	0.050	0.00	1.27	
V	0.045		1.15		
Z		0.080		2.04	

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982
- 2. CONTROLLING DIMENSION: INCH.
- 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

Part Marking System



TO-220AB CASE 221A-07



MCR72-6TG AKA

TO-220AB

CASE 221A-09

AY WW

 A=
 Assembly Location

 Y=
 Year

 WW
 = Work Week

 MCR72-6T
 = Device Code

 G
 = Pb-Free Package

 AKA=
 Diode Polarity

Pin Assignment	
1	Cathode
2	Anode
3	Gate
4	Anode

Device Package Shipping MCR72-3G 500 Units / Box MCR72-6G TO-220AB (Pb-Free) 50 Units / Box MCR72-8G 500 Units / Box MCR72-8TG 50 Units / Box

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